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SINGLE 5-Ω SP3T ANALOG SWITCH 5-V/3.3-V 3:1 MULTIPLEXER/DEMULTIPLEXER

Check for Samples: TS5A3357-Q1

FEATURES

- Qualified for Automotive Applications
- Specified Break-Before-Make Switching
- Low ON-State Resistance
- High Bandwidth
- Control Inputs Are 5.5-V Tolerant
- Low Charge Injection
- Excellent ON-State Resistance Matching
- Low Total Harmonic Distortion (THD)
- 1.65-V to 5.5-V Single-Supply Operation
- Latch Up Exceeds 100 mA per JESD78B, Class I

SC-70 (DCU) PACKAGE (TOP VIEW) TS5A3357 8 NO₀ V_{\perp} 7 NO₁ COM NO2 6 IN1 Logic 5 GND IN₂ Contro

DESCRIPTION/ORDERING INFORMATION

The TS5A3357 is a high-performance, single-pole triple throw (SP3T) analog switch that is designed to operate from 1.65 V to 5.5 V. The device offers a low ON-state resistance and low input/output capacitance and, thus, causes a very low signal distortion. The break-before-make feature allows transferring of a signal from one port to another, with a minimal signal distortion. This device also offers a low charge injection which makes this device suitable for high-performance audio and data acquisition systems.

Table 1. Summary of Characteristics⁽¹⁾

| Configuration | Triple 3:1 Multiplexer/ Demultiplexer (1 × SP3T) |
|--|--|
| Number of channels | STATE TO A STATE OF THE STATE O |
| ON-state resistance (ron) | 5 Ω |
| ON-state resistance match (Δr _{on}) | 0.1 Ω |
| ON-state resistance flatness (ron(flat)) | 6.5 Ω |
| Turn-on/turn-off time (t _{ON} /t _{OFF}) | 6.5 ns/3.7 ns |
| Break-before-make time (t _{BBM}) ⁽²⁾ | 0.5 ns |
| Charge injection (Q _C) | 3.4 pC |
| Bandwidth (BW) | 334 MHz |
| OFF isolation (O _{ISO}) | -82 dB at 10 MHz |
| Crosstalk (X _{TALK}) | _62 dB at 10 MHz |
| Total harmonic distortion (THD) | 0.05% |
| Leakage current (I _{COM(OFF)}) | ±1 μA |
| Package option | 8-pin DCU (US8) |

⁽¹⁾ $V_{+} = 5 \text{ V}, T_{A} = 25^{\circ}\text{C}$



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Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

⁽²⁾ Specified by designed. Not production tested.



Table 2. FUNCTION TABLE

| IN1 | IN2 | COM TO NO0 | COM TO NO1 | COM TO NO2 |
|-----|-----|------------|------------|------------|
| L | L | OFF | OFF | OFF |
| Н | L | L ON OFF | | OFF |
| L | Н | OFF | ON | OFF |
| Н | Н | OFF | OFF | ON |

Table 3. ORDERING INFORMATION⁽¹⁾

| | T _A | PACKAGE (2) | | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|---|----------------|-------------|--------------|-----------------------|------------------|--|
| Ī | -40°C to 125°C | SOT - DCU | Reel of 3000 | TS5A3357QDCURQ1 | JAVR | |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
- (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

ABSOLUTE MINIMUM AND MAXIMUM RATINGS(1) (2)

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|--------------------|---|--------------------|------|-----|------|
| V ₊ | Supply voltage range ⁽³⁾ | | -0.5 | 6.5 | V |
| $V_{NO} \ V_{COM}$ | Analog voltage range ⁽³⁾ (4) (5) | | | | |
| I_{K} | Analog port diode current | -50 | 50 | mA | |
| I_{NO} I_{COM} | On-state switch current | -100 | 100 | mA | |
| VI | Digital input voltage range (3) (4) | | -0.5 | 6.5 | V |
| I _{IK} | Digital input clamp current | V _I < 0 | -50 | | mA |
| I ₊ | Continuous current through V ₊ | | | 100 | mA |
| I _{GND} | Continuous current through GND | | -100 | 100 | mA |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.
- (3) All voltages are with respect to ground, unless otherwise specified.
- (4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (5) This value is limited to 5.5 V maximum.

PACKAGE THERMAL IMPEDANCE

| | | MAX | UNIT |
|---------------|--|-----|------|
| θ_{JA} | Package thermal impedance ⁽¹⁾ | 165 | °C/W |

(1) The package thermal impedance is calculated in accordance with JESD 51-7.

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ELECTRICAL CHARACTERISTICS FOR 5-V SUPPLY⁽¹⁾

 $V_{\star} = 4.5 \text{ V}$ to 5.5 V_{\star} $T_{\wedge} = -40^{\circ}\text{C}$ to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CO | ONDITIONS | TA | V ₊ | MIN | TYP | MAX | UNIT |
|--|-----------------------------------|---|-----------------------------|------|----------------|--------------------|-----|----------------------|------|
| Analog Switch | | | | | | | | | |
| Analog signal range | V_{COM}, V_{NO} | | | | | 0 | | V ₊ | V |
| Peak ON resistance | r _{peak} | $0 \le V_{NO} \le V_+,$ $I_{COM} = -30 \text{ mA},$ | Switch ON, See Figure 13 | Full | 4.5 V | | | 15 | Ω |
| | | $V_{NO} = 0$, | | 25°C | | | 5 | 7 | |
| | | $I_{COM} = 30 \text{ mA}$ | | Full | | | | 7 | |
| ON-state resistance | _ | V _{NO} = 2.4 V, | Switch ON, | 25°C | 4.5 V | | 6 | 12 | Ω |
| ON-State resistance | r _{on} | $I_{COM} = -30 \text{ mA}$ | See Figure 13 | Full | 4.5 V | | | 12 | 12 |
| | | $V_{NO} = 4.5 V,$ | | 25°C | | | 7 | 15 | |
| | | $I_{COM} = -30 \text{ mA}$ | | Full | | | | 15 | |
| ON-state resistance match between channels | Δr _{on} | $V_{NO} = 3.15 \text{ V},$ $I_{COM} = -30 \text{ mA},$ | Switch ON, See Figure 13 | 25°C | 4.5 V | | 0.1 | | Ω |
| ON-state resistance flatness | r _{on(flat)} | $0 \le V_{NO} \le V_+,$ $I_{COM} = -30 \text{ mA},$ | Switch ON, See Figure 13 | 25°C | 5 V | | 6.5 | | Ω |
| NO | 1 | $V_{NO} = 0$ to V_+ , | Switch OFF, | 25°C | 5.5 V | -0.2 | | 0.2 | μA |
| OFF leakage current | I _{NO(OFF)} | $V_{COM} = V_{+}$ to 0 | See Figure 14 | Full | 3.3 V | -1 | | 1 | μΑ |
| COM | ı | $V_{COM} = 0 \text{ to } V_+,$ | Switch OFF, | 25°C | 0 | -0.2 | | 0.2 | μA |
| OFF leakage current | I _{COM(OFF)} | $V_{NO} = V_{+}$ to 0, | See Figure 14 | Full | U | -1 | | 1 | μΑ |
| NO | 1 | $V_{NO} = 0$ to V_+ , | Switch ON, | 25°C | 5.5 V | -0.2 | | 0.2 | μA |
| ON leakage current | I _{NO(ON)} | V _{COM} = Open, | See Figure 14 | Full | 3.5 V | -1 | | 1 | μΑ |
| COM | | V _{NO} = Open, | Switch ON, | 25°C | 5.5 V | -0.2 | | 0.2 | |
| ON leakage current | I _{COM(ON)} | $V_{COM} = 0$ to V_+ , | See Figure 14 | Full | 3.5 V | -1 | | 1 | μA |
| Digital Control Input | s (IN1, IN2) ⁽ | 2) | | | | | | | |
| Input logic high | V _{IH} | | | Full | | $V_{+} \times 0.7$ | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | | V ₊ × 0.3 | V |
| Input leakage | L. L. | V _I = 5.5 V or 0 | | 25°C | 5.5 V | | | 0.1 | μA |
| current | I _{IH} , I _{IL} | v ₁ = 3.5 v 0i 0 | | Full | 5.5 v | | | 1 | μΑ |

The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum All unused digital inputs of the device must be held at V_+ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



ELECTRICAL CHARACTERISTICS FOR 5-V SUPPLY (1) (continued)

 $V_{+} = 4.5 \text{ V}$ to 5.5 V, $T_{A} = -40^{\circ}\text{C}$ to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CO | NDITIONS | TA | V ₊ | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|------------------------------|------|----------------|-----|------|-----|------|
| Dynamic | • | | | | | | | ., | |
| Towns on these | | $V_{NO} = V_{+}$ or GND, | $C_1 = 50 \text{ pF},$ | 25°C | 5 V | 1.5 | | 10 | |
| Turn-on time | t _{ON} | $R_L = 500 \Omega$, | See Figure 16 | Full | 4.5 V to 5.5 V | 1.5 | | 10 | ns |
| Turn-off time | | $V_{NO} = V_{+}$ or GND, | $C_1 = 50 \text{ pF},$ | 25°C | 5 V | 0.8 | | 6.5 | |
| rum-on ume | t _{OFF} | $R_L = 500 \Omega$, | See Figure 16 | Full | 4.5 V to 5.5 V | 0.8 | | 7 | ns |
| Break-before- | | $V_{NO} = V_+,$ | $C_{L} = 50 \text{ pF},$ | 25°C | 5 V | 0.5 | | | |
| make time ⁽³⁾ | t _{BBM} | $R_L = 50 \Omega$, | See Figure 17 | Full | 4.5 V to 5.5 V | 0.5 | | | ns |
| Charge injection | $Q_{\mathbb{C}}$ | $V_{GEN} = 0,$ $C_L = 0.1 \text{ nF},$ | See Figure 21 | 25°C | 5 V | | 3.4 | | рС |
| NO OFF capacitance | C _{NO(OFF)} | $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 15 | 25°C | 5 V | | 4.5 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 15 | 25°C | 5 V | | 10.5 | | pF |
| NO ON capacitance | C _{NO(ON)} | $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 15 | 25°C | 5 V | | 17 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 15 | 25°C | 5 V | | 17 | | рF |
| Digital input capacitance | C _I | $V_I = V_+ \text{ or GND},$ | See Figure 15 | 25°C | 5 V | | 3 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 4.5 V to 5.5 V | | 334 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 10 MHz, | Switch OFF, See Figure 19 | 25°C | 4.5 V to 5.5 V | | -82 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega$, f = 10 MHz, | Switch ON, See Figure 20 | 25°C | 4.5 V to 5.5 V | | -62 | | dB |
| Supply | | T. | | | 1 | | | l | |
| Positive supply | | V V or CND | Switch ON or | 25°C | E E V | | | 1 | |
| current | I ₊ | $V_I = V_+ \text{ or GND},$ | OFF | Full | 5.5 V | | | 10 | μΑ |

⁽³⁾ Specified by designed. Not production tested.

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ELECTRICAL CHARACTERISTICS FOR 3.3-V SUPPLY⁽¹⁾

 $V_{+} = 3 \text{ V to } 3.6 \text{ V}, T_{\Delta} = -40^{\circ}\text{C to } 125^{\circ}\text{C} \text{ (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST C | ONDITIONS | T_A | V_{+} | MIN | TYP | MAX | UNIT |
|--|-----------------------------------|--|-----------------------------|-------|---------|--------------------|------|----------------------|----------|
| Analog Switch | | | | | | | | | |
| Analog signal range | V_{COM}, V_{NO} | | | | | 0 | | V ₊ | V |
| Peak ON resistance | r _{peak} | $0 \le V_{NO} \le V_+,$ $I_{COM} = -24 \text{ mA},$ | Switch ON, See Figure 13 | Full | 3 V | | | 25 | Ω |
| | | $V_{NO} = 0 V$, | | 25°C | | | 6.5 | 9 | |
| ON-state resistance | _ | $I_{COM} = 24 \text{ mA}$ | Switch ON, | Full | 2.1/ | | | 9 | 0 |
| ON-state resistance | r _{on} | V _{NO} = 3 V, | See Figure 13 | 25°C | 3 V | | 9 | 20 | 1 12 |
| | | $I_{COM} = -24 \text{ mA}$ | | Full | | | | 20 | |
| ON-state resistance match between channels | Δr _{on} | $V_{NO} = 2.1 \text{ V},$ $I_{COM} = -24 \text{ mA},$ | Switch ON, See Figure 13 | 25°C | 3 V | | 0.1 | | Ω |
| ON-state resistance flatness | r _{on(flat)} | $0 \le V_{NO} \le V_+,$ $I_{COM} = -24 \text{ mA},$ | Switch ON, See Figure 13 | 25°C | 3.3 V | | 13.5 | | Ω |
| NO | | $V_{NO} = 0$ to V_+ | Switch OFF, | 25°C | 3.6 V | -0.2 | | 0.2 | |
| OFF leakage current | I _{NO(OFF)} | $V_{COM} = V_{+}$ to 0 | See Figure 14 | Full | 3.0 V | -1 | | 1 | μA |
| COM | 1 | $V_{COM} = 0 \text{ to } V_+,$ | Switch OFF, | 25°C | 3.6 V | -0.2 | | 0.2 | μA |
| OFF leakage current | I _{COM(OFF)} | $V_{NO} = V_{+}$ to 0, | See Figure 14 | Full | 3.0 V | -1 | | 1 | μΑ |
| NO | 1 | $V_{NO} = 0$ to V_+ , | Switch ON, | 25°C | 3.6 V | -0.2 | | 0.2 | |
| ON leakage current | I _{NO(ON)} | $V_{COM} = V_{+}$ to 0, | See Figure 14 | Full | 3.0 V | -1 | | 1 | μA |
| COM | | V _{NO} = Open, | Switch ON, | 25°C | 3.6 V | -0.2 | | 0.2 | |
| ON leakage current | I _{COM(ON)} | $V_{COM} = 0$ to V_+ , | See Figure 14 | Full | 3.0 V | -1 | | 1 | μA |
| Digital Control Input | ts (IN1, IN2) | (2) | | | | | | | |
| Input logic high | V _{IH} | | | Full | | $V_{+} \times 0.7$ | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | | V ₊ × 0.3 | V |
| Input leakage | I _{IH} , I _{IL} | V _I = 5.5 V or 0 | | 25°C | 3.6 V | -1 | | 0.1 | μA |
| current | 1117 11 | | | Full | | | | 1 | , par. 1 |

The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

All unused digital inputs of the device must be held at V+ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



ELECTRICAL CHARACTERISTICS FOR 3.3-V SUPPLY (1) (continued)

 $V_{+} = 3 \text{ V to } 3.6 \text{ V}, T_{A} = -40 ^{\circ}\text{C to } 125 ^{\circ}\text{C} \text{ (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST C | ONDITIONS | TA | V ₊ | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|------------------------------|------|----------------|-----|------|------|------|
| Dynamic | | | | | | | | | |
| Turn-on time | t _{ON} | $V_{NO} = V_{+}$ or GND, | C _L = 50 pF, | 25°C | 3.3 V | 2 | | 12 | ns |
| rain on time | ON | $R_L = 500 \Omega$ | See Figure 16 | Full | 3 V to 3.6 V | 2 | | 12.9 | 110 |
| Turn-off time | + | $V_{NO} = V_{+}$ or GND, | $C_L = 50 \text{ pF},$ | 25°C | 3.3 V | 1.3 | | 8 | ns |
| rum-on time | t _{OFF} | $R_L = 500 \Omega$ | See Figure 16 | Full | 3 V to 3.6 V | 1.5 | | 8 | 20 |
| Break-before- | t _{BBM} | $V_{NO} = V_{+}$ | $C_L = 50 \text{ pF},$ | 25°C | 3.3 V | 0.5 | | | ns |
| make time ⁽³⁾ | , BBM | $R_L = 50 \Omega$, | See Figure 17 | Full | 3 V to 3.6 V | 0.5 | | | 110 |
| Charge injection | Q_{C} | $V_{GEN} = 0,$ $C_L = 0.1 \text{ nF},$ | See Figure 21 | 25°C | 3.3 V | | 1.75 | | рС |
| NO OFF capacitance | C _{NO(OFF)} | V _{NO} = V ₊ or GND, Switch OFF, | See Figure 15 | 25°C | 3.3 V | | 4.5 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | V _{NO} = V ₊ or GND, Switch OFF, | See Figure 15 | 25°C | 3.3 V | | 10.5 | | pF |
| NO ON capacitance | C _{NO(ON)} | V _{NO} = V ₊ or GND, Switch ON, | See Figure 15 | 25°C | 3.3 V | | 17 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 15 | 25°C | 3.3 V | | 17 | | pF |
| Digital input capacitance | Cı | $V_I = V_+ \text{ or GND},$ | See Figure 15 | 25°C | 3.3 V | | 3 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 3 V to 3.6 V | | 327 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega,$ f = 10 MHz, | Switch OFF, See Figure 19 | 25°C | 3 V to 3.6 V | | -82 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega$, $f = 10 MHz$, | Switch ON, See Figure 20 | 25°C | 3 V to 3.6 V | | -62 | | dB |
| Supply | | | | | | | | | |
| Positive supply | I ₊ | $V_1 = V_+$ or GND, | Switch ON or OFF | 25°C | 3.6 V | | | 1 | μA |
| current | '+ | 1, 1, 1, 0, 0, 0, | | Full | 0.0 . | | | 10 | μ, , |

⁽³⁾ Specified by designed. Not production tested.



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ELECTRICAL CHARACTERISTICS FOR 2.5-V SUPPLY⁽¹⁾

= 2.3 V to 2.7 V. T. = -40° C to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CO | ONDITIONS | T_A | V ₊ | MIN | TYP | MAX | UNIT |
|---|------------------------------------|---|-----------------------------|-------|----------------|---------------------|-----|---------------------|------|
| Analog Switch | | | | | | | | | |
| Analog signal range | V _{COM} , V _{NO} | | | | | 0 | | V ₊ | V |
| Peak ON resistance | r _{peak} | $0 \le V_{NO} \le V_+,$ $I_{COM} = -8 \text{ mA},$ | Switch ON, See Figure 13 | Full | 2.3 V | | | 50 | Ω |
| | | $V_{NO} = 0 V$ | | 25°C | | | 8 | 12 | |
| ON-state | , | $I_{COM} = 8 \text{ mA}$ | Switch ON, | Full | 2.3 V | | | 12 | Ω |
| resistance | r _{on} | $V_{NO} = 2.3 V,$ | See Figure 13 | 25°C | 2.5 V | | 11 | 30 | 32 |
| | | $I_{COM} = -8 \text{ mA}$ | | Full | | | | 30 | |
| ON-state resistance match between channels | Δr _{on} | $V_{NO} = 1.8 \text{ V},$ $I_{COM} = -8 \text{ mA},$ | Switch ON, See Figure 13 | 25°C | 2.3 V | | 0.3 | | Ω |
| ON-state resistance flatness | r _{on(flat)} | $0 \le V_{NO} \le V_{+},$ $I_{COM} = -8 \text{ mA},$ | Switch ON, See Figure 13 | 25°C | 2.5 V | | 39 | | Ω |
| NO | | $V_{NO} = 0$ to V_+ , | Switch OFF, | 25°C | | -0.2 | | 0.2 | |
| OFF leakage current | I _{NO(OFF)} | $V_{COM} = V_{+} \text{ to } 0$ | See Figure 14 | Full | 2.7 V | -1 | | 1 | μA |
| COM | | $V_{COM} = 0 \text{ to } V_+,$ | Switch OFF, | 25°C | | -0.2 | | 0.2 | |
| OFF leakage current | I _{COM(OFF)} | $V_{NO} = V_{+} \text{ to } 0,$ | See Figure 14 | Full | 2.7 V | -1 | | 1 | μA |
| NO | | $V_{NO} = 0$ to V_+ , | Switch ON, | 25°C | | -0.2 | | 0.2 | |
| ON leakage current | I _{NO(ON)} | $V_{COM} = V_+ \text{ to } 0,$ | See Figure 14 | Full | 2.7 V | -1 | | 1 | μA |
| СОМ | | V _{NO} = Open, | Switch ON, | 25°C | | -0.2 | | 0.2 | |
| ON leakage current | I _{COM(ON)} | $V_{COM} = 0 \text{ to } V_+,$ | See Figure 14 | Full | 2.7 V | -1 | | 1 | μA |
| Digital Control Inp | uts (IN1, IN2 | ⁽²⁾ | | | | | | | |
| Input logic high | V _{IH} | | | Full | | $V_{+} \times 0.75$ | | 5.5 | V |
| Input logic low | V_{IL} | | | Full | | 0 | | $V_{+} \times 0.25$ | V |
| Input leakage | I _{IH} , I _{IL} | V _I = 5.5 V or 0 | | 25°C | 2.7 V | | | 0.1 | μA |
| current | 'IH', 'IL | V ₁ = 0.0 V 01 0 | | Full | Z.1 V | | | 1 | μΑ |

The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

Product Folder Link(s): TS5A3357-Q1

All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



ELECTRICAL CHARACTERISTICS FOR 2.5-V SUPPLY (1) (continued)

 $V_{+} = 2.3 \text{ V}$ to 2.7 V, $T_{A} = -40^{\circ}\text{C}$ to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CO | ONDITIONS | T_A | V ₊ | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|------------------------------|-------|----------------|-----|-----------------|------|------|
| Dynamic | | | | * | | | | | |
| Turn-on time | | $V_{NO} = V_{+}$ or GND, | $C_L = 50 \text{ pF},$ | 25°C | 2.5 V | 3 | | 15 | ne |
| rum-on time | t _{ON} | $R_L = 500 \Omega$ | See Figure 16 | Full | 2.3 V to 2.7 V | 3 | | 19.4 | ns |
| Turn-off time | t | $V_{NO} = V_{+}$ or GND, | $C_{L} = 50 \text{ pF},$ | 25°C | 2.5 V | 2 | | 8.1 | ns |
| rum-on ume | t _{OFF} | $R_L = 500 \Omega$ | See Figure 16 | Full | 2.3 V to 2.7 V | 2 | | 10 | 113 |
| Break-before- | t _{BBM} | $V_{NO} = V_+,$ | $C_L = 50 \text{ pF},$ | 25°C | 2.5 V | 0.5 | | | ns |
| make time ⁽³⁾ | BBM | $R_L = 50 \Omega$, | See Figure 17 | Full | 2.3 V to 2.7 V | 0.5 | | | 110 |
| Charge injection | Q_C | $V_{GEN} = 0,$ $C_L = 0.1 \text{ nF},$ | See Figure 21 | 25°C | 2.5 V | | 1.15 | | pC |
| NO OFF capacitance | C _{NO(OFF)} | V _{NO} = V ₊ or GND, Switch OFF, | See Figure 15 | 25°C | 2.5 V | | 4.5 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | V _{NO} = V ₊ or GND, Switch OFF, | See Figure 15 | 25°C | 2.5 V | | 10.5 | | pF |
| NO ON capacitance | C _{NO(ON)} | V _{NO} = V ₊ or GND, Switch ON, | See Figure 15 | 25°C | 2.5 V | | 17 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 15 | 25°C | 2.5 V | | 17 | | pF |
| Digital input capacitance | C _I | $V_I = V_+ \text{ or GND},$ | See Figure 15 | 25°C | 2.5 V | | 3 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 2.3 V to 2.7 V | | 320 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 10 MHz, | Switch OFF, See Figure 19 | 25°C | 2.3 V to 2.7 V | | -81 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega$, f = 10 MHz, | Switch ON, See Figure 20 | 25°C | 2.3 V to 2.7 V | | - 61 | | dB |
| Supply | | | | | , ' | | | | |
| Positive supply | l ₊ | $V_1 = V_+$ or GND, | Switch ON or | 25°C | 2.7 V | | | 1 | |
| current | 1+ | $v_1 = v_+ \cup i \cup i \cup i \cup j$ | OFF | Full | Z.1 V | | | 10 | μA |

⁽³⁾ Specified by designed. Not production tested.



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SCDS290 - AUGUST 2009

ELECTRICAL CHARACTERISTICS FOR 1.8-V SUPPLY⁽¹⁾

 $V_{+} = 1.65 \text{ V}$ to 1.95 V, $T_{A} = -40 ^{\circ}\text{C}$ to 125 °C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CO | ONDITIONS | TA | V ₊ | MIN | TYP | MAX | UNIT |
|---|------------------------------------|---|-----------------------------|--------------|----------------|-----------------------|-----|---------------------|------|
| Analog Switch | | | | | | | | | |
| Analog signal range | V _{COM} , V _{NO} | | | | | 0 | | V_{+} | ٧ |
| Peak ON resistance | r _{peak} | $0 \le V_{NO} \le V_+,$ $I_{COM} = -4 \text{ mA},$ | Switch ON, See Figure 13 | Full | 1.65 V | | | 150 | Ω |
| | | $V_{NO} = 0 V$, | | 25°C | | | 10 | 20 | |
| ON-state | _ | I _{COM} = 4 mA | Switch ON, | Full | 1.65 V | | | 20 | Ω |
| resistance | r _{on} | V _{NO} = 1.8 V, | See Figure 13 | 25°C | 1.00 V | | 17 | 50 | Ω |
| | | $I_{COM} = -4 \text{ mA}$ | | Full | | | | 50 | |
| ON-state resistance match between channels | Δr _{on} | $V_{NO} = 1.15 \text{ V},$ $I_{COM} = -4 \text{ mA},$ | Switch ON, See Figure 13 | 25°C | 1.65 V | | 0.3 | | Ω |
| ON-state resistance flatness | r _{on(flat)} | $0 \le V_{NO} \le V_{+},$ $I_{COM} = -4 \text{ mA},$ | Switch ON, See Figure 13 | 25°C | 1.8 V | | 140 | | Ω |
| NO | _ | $V_{NO} = 0$ to V_+ , | Switch OFF, | 25°C | | -0.2 | | 0.2 | |
| OFF leakage current | I _{NO(OFF)} | $V_{COM} = V_+ \text{ to } 0$ | See Figure 14 | Full | 1.95 V | -1 | | 1 | μA |
| COM | | $V_{COM} = 0$ to V_+ , | Switch OFF, | 25°C | | -0.2 | | 0.2 | |
| OFF leakage current | I _{COM(OFF)} | $V_{NO} = V_{+}$ to 0, | See Figure 14 | Full | 1.95 V | -1 | | 1 | μA |
| NO | | $V_{NO} = 0$ to V_{+} | Switch ON, | 25°C | | -0.2 | | 0.2 | |
| ON leakage current | I _{NO(ON)} | $V_{COM} = V_+ \text{ to } 0,$ | See Figure 14 | Full | 1.95 V | -1 | | 1 | μA |
| COM | | V _{NO} = Open, | Switch ON, | 25°C | | -0.2 | | 0.2 | |
| ON leakage current | I _{COM(ON)} | $V_{COM} = 0 \text{ to } V_+,$ | See Figure 14 | Full | 1.95 V | -1 | | 1 | μA |
| Digital Control Inpu | uts (IN1, IN2 |) ⁽²⁾ | | | | | | | |
| Input logic high | V _{IH} | | | Full | | V ₊ × 0.75 | | 5.5 | V |
| Input logic low | V_{IL} | | | Full | | 0 | | $V_{+} \times 0.25$ | V |
| Input leakage current | I _{IH} , I _{IL} | V _I = 5.5 V or 0 | | 25°C Full | 1.95 V | | | 0.1 | μA |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

⁽²⁾ All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



ELECTRICAL CHARACTERISTICS FOR 1.8-V SUPPLY (1) (continued)

 V_{+} = 1.65 V to 1.95 V, T_{A} = -40°C to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST COM | NDITIONS | TA | V ₊ | MIN | TYP | MAX | UNIT |
|--------------------------------|-----------------------|---|--|------|---------------------|-----|------|------|------|
| Dynamic | | | | • | | | | | |
| | | V V or CND | C | 25°C | 1.8 V | 5 | | 32 | |
| Turn-on time | t _{ON} | $V_{NO} = V_{+} \text{ or GND},$ $R_{L} = 500 \Omega,$ | C _L = 50 pF, See Figure 16 | Full | 1.65 V to 1.95 V | 5 | | 40 | ns |
| | | V - V or CND | C = 50 pF | 25°C | 1.8 V | 3 | | 14 | |
| Turn-off time | t _{OFF} | $V_{NO} = V_{+} \text{ or GND},$ $R_{L} = 500 \Omega,$ | See Figure 16 | Full | 1.65 V to 1.95 V | 3 | | 17.6 | ns |
| Dunal, hafana | | V V | 0 50 - 5 | 25°C | 1.8 V | 0.5 | | | |
| Break-before- make time (3) | t _{BBM} | $V_{NO} = V_+,$ $R_L = 50 \Omega,$ | C _L = 50 pF, See Figure 17 | Full | 1.65 V to 1.95 V | 0.5 | | | ns |
| Charge injection | Q _C | $V_{GEN} = 0,$ $C_L = 0.1 \text{ nF},$ | See Figure 21 | 25°C | 1.8 V | | 0.3 | | pC |
| NO OFF capacitance | C _{NO(OFF)} | $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 15 | 25°C | 1.8 V | | 4.5 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 15 | 25°C | 1.8 V | | 10.5 | | pF |
| NO ON capacitance | C _{NO(ON)} | $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 15 | 25°C | 1.8 V | | 17 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 15 | 25°C | 1.8 V | | 17 | | pF |
| Digital input capacitance | C _I | $V_I = V_+$ or GND, | See Figure 15 | 25°C | 1.8 V | | 3 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 1.65 V to 1.95 V | | 341 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 10 MHz, | Switch OFF, See Figure 19 | 25°C | 1.65 V to 1.95 V | | -81 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega$, f = 10 MHz, | Switch ON, See Figure 20 | 25°C | 1.65 V to 1.95 V | | -61 | | dB |
| Supply | | | | • | | | | | |
| Positive supply | 1 | $V_1 = V_+$ or GND, | Switch ON or | 25°C | 1.95 V | | | 1 | |
| current | I ₊ | $v_{\parallel} = v_{+} \cup i \cup i \cup i \cup j$ | OFF | Full | 1.90 V | | | 10 | μΑ |

⁽³⁾ Specified by designed. Not production tested.

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3.5



TYPICAL PERFORMANCE

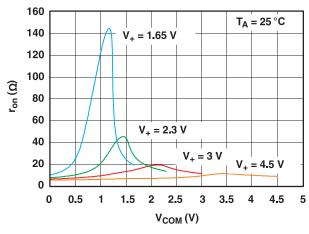
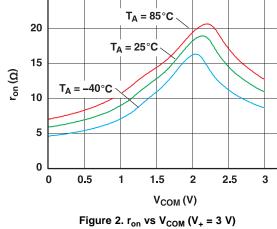


Figure 1. r_{on} vs V_{COM}



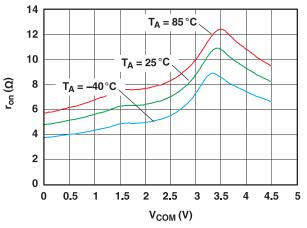


Figure 3. r_{on} vs V_{COM} ($V_{+} = 4.5 \text{ V}$)

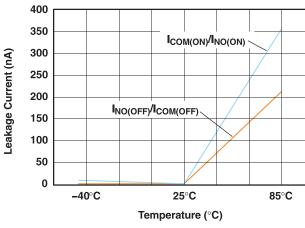


Figure 4. Leakage Current vs Temperature ($V_{+} = 5.5 \text{ V}$)

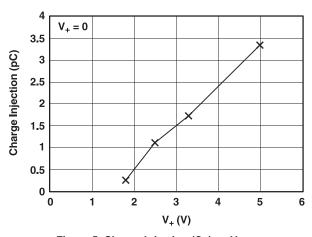


Figure 5. Charge Injection (Q_C) vs V_{COM}

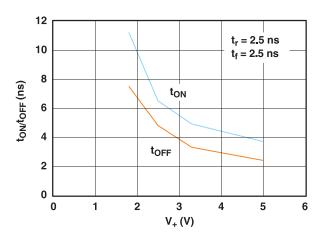


Figure 6. t_{ON} and t_{OFF} vs V_{+}



TYPICAL PERFORMANCE (continued)

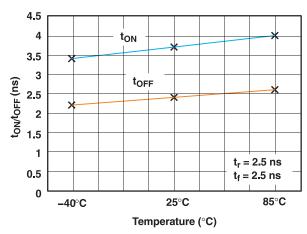


Figure 7. t_{ON} and t_{OFF} vs Temperature (V₊ = 5 V)

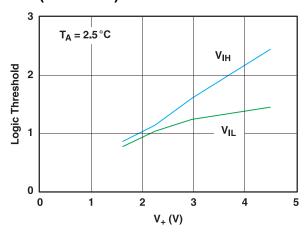


Figure 8. Logic-Level Threshold vs V₊

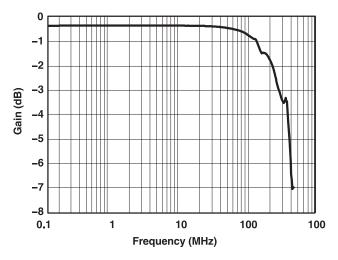


Figure 9. Frequency Response $(V_+ = 3 V)$

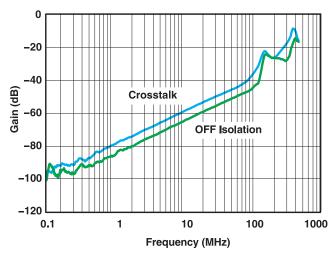


Figure 10. OFF Isolation and Crosstalk vs Frequency (V $_{\star}$ = 3 V)

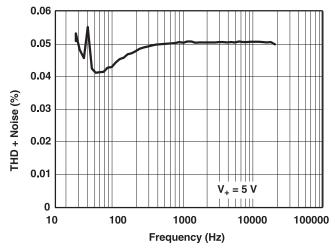


Figure 11. Total Harmonic Distortion vs Frequency $(V_+ = 5 V)$

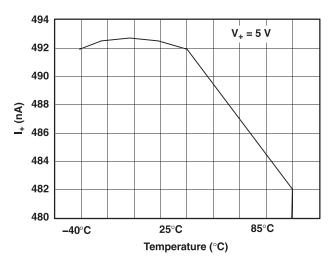


Figure 12. Power-Supply Current vs Temperature $(V_+ = 5 V)$

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Table 4. PIN DESCRIPTION

| PIN NO. | NAME | DESCRIPTION |
|---------|----------------|--------------------------------------|
| 1 | NO0 | Normally open |
| 2 | NO1 | Normally open |
| 3 | NO2 | Normally open |
| 4 | GND | Digital ground |
| 5 | IN2 | Digital control to connect COM to NO |
| 6 | IN1 | Digital control to connect COM to NO |
| 7 | COM | Common |
| 8 | V ₊ | Power supply |

Table 5. PARAMETER DESCRIPTION

| SYMBOL | DESCRIPTION |
|-----------------------------------|--|
| V _{COM} | Voltage at COM |
| V _{NO} | Voltage at NO |
| r _{on} | Resistance between COM and NC or COM and NO ports when the channel is ON |
| r _{peak} | Peak on-state resistance over a specified voltage range |
| Δr_{on} | Difference of r _{on} between channels in a specific device |
| r _{on(flat)} | Difference between the maximum and minimum value of ron in a channel over the specified range of conditions |
| I _{NO(OFF)} | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state |
| I _{NO(ON)} | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open |
| I _{COM(ON)} | Leakage current measured at the COM port, with the corresponding channel (COM to NO or COM to NC) in the ON state and the output (NC or NO) open |
| I _{COM(OFF)} | Leakage current measured at the COM port during the power-down condition, V ₊ = 0 |
| V _{IH} | Minimum input voltage for logic high for the control input (IN) |
| V _{IL} | Maximum input voltage for logic low for the control input (IN) |
| VI | Voltage at the control input (IN) |
| I _{IH} , I _{IL} | Leakage current measured at the control input (IN) |
| t _{ON} | Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON. |
| t _{OFF} | Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. |
| t _{BBM} | Break-before-make time. This parameter is measured under the specified range of conditions and by the propagation delay between the output of two adjacent analog channels (NC and NO) when the control signal changes state. |
| Q _C | Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$, C_L is the load capacitance and ΔV_{COM} is the change in analog output voltage. |
| C _{NO(OFF)} | Capacitance at the NO port when the corresponding channel (NO to COM) is OFF |
| C _{NO(ON)} | Capacitance at the NO port when the corresponding channel (NO to COM) is ON |
| C _{COM(ON)} | Capacitance at the COM port when the corresponding channel (COM to NO) is ON |
| C _{COM(OFF)} | Capacitance at the COM port when the corresponding channel (COM to NO) is OFF |
| C _I | Capacitance of control input (IN) |
| O _{ISO} | OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NC to COM or NO to COM) in the OFF state. |
| X _{TALK} | Crosstalk is a measurement of unwanted signal coupling from an ON channel to an OFF channel (NC to NO or NO to NC). This is measured in a specific frequency and in dB. |
| BW | Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain. |
| I ₊ | Static power-supply current with the control (IN) pin at V ₊ or GND |



PARAMETER MEASUREMENT INFORMATION

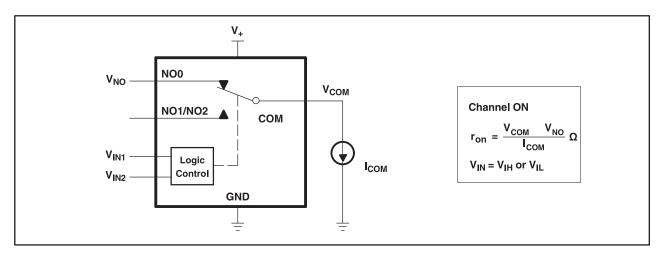


Figure 13. ON-State Resistance (ron)

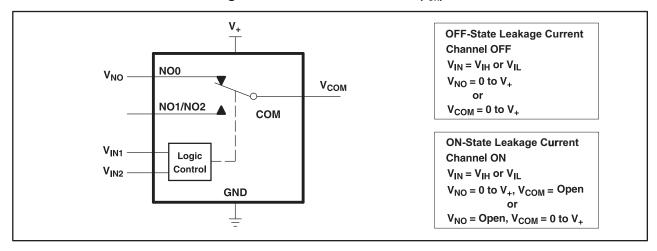


Figure 14. ON- and OFF-State Leakage Current ($I_{COM(ON)}$, $I_{COM(OFF)}$, $I_{NO(ON)}$, $I_{NO(OFF)}$)

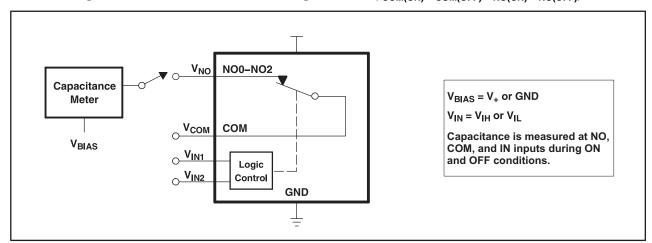


Figure 15. Capacitance (C_I, $C_{COM(ON)}$, $C_{NO(OFF)}$, $C_{COM(OFF)}$, $C_{NO(ON)}$)

- A. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r < 5$ ns, $t_f < 5$ ns.
- B. C_L includes probe and jig capacitance.

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PARAMETER MEASUREMENT INFORMATION (continued)

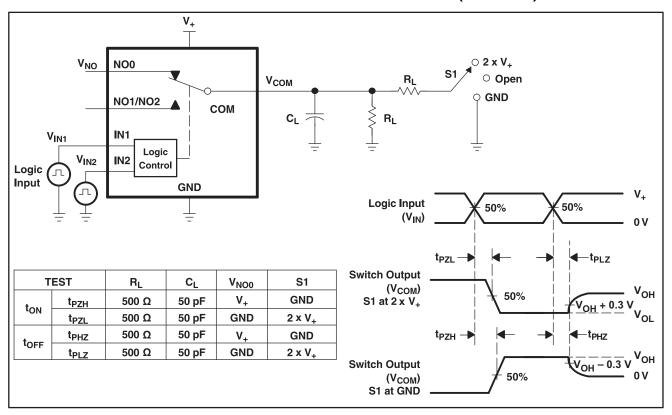


Figure 16. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r < 5 \text{ ns}$, $t_f < 5 \text{ ns}$.
- D. C_L includes probe and jig capacitance.

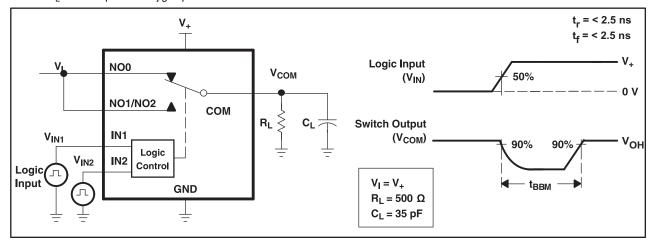


Figure 17. Break-Before-Make Time (t_{BBM})



PARAMETER MEASUREMENT INFORMATION (continued)

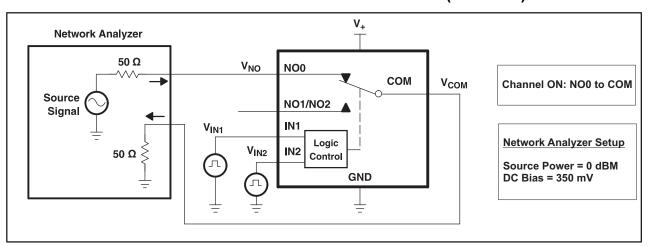


Figure 18. Bandwidth (BW)

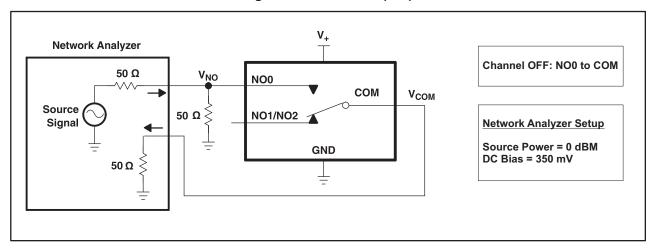


Figure 19. OFF Isolation (O_{ISO})

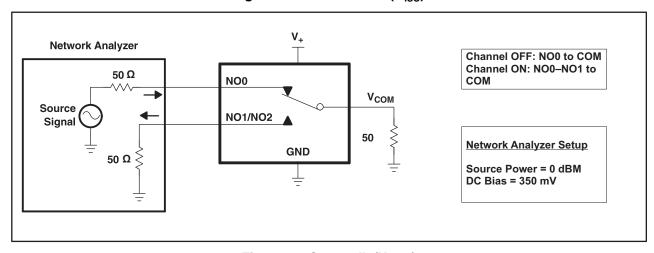


Figure 20. Crosstalk (X_{TALK})

- E. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r < 5$ ns, $t_f < 5$ ns.
- F. C_L includes probe and jig capacitance.

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PARAMETER MEASUREMENT INFORMATION (continued)

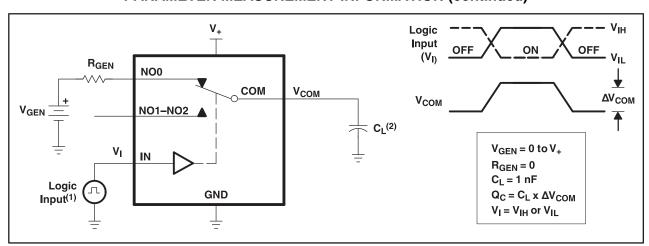


Figure 21. Charge Injection (Q_C)



PACKAGE OPTION ADDENDUM

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29-Sep-2009

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins Pa | ckage Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|---------|--------------|-------------------------|------------------|------------------------------|
| TS5A3357QDCURQ1 | ACTIVE | US8 | DCU | 8 : | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF TS5A3357-Q1:

• Catalog: TS5A3357

NOTE: Qualified Version Definitions:

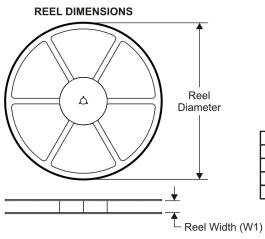
Catalog - TI's standard catalog product

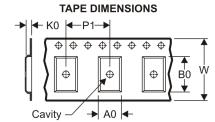


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1-Oct-2009

TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

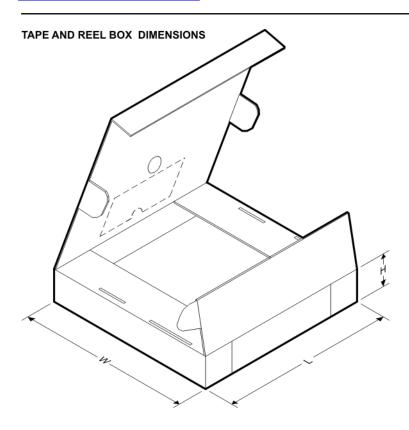


*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TS5A3357QDCURQ1 | US8 | DCU | 8 | 3000 | 180.0 | 9.2 | 2.25 | 3.35 | 1.05 | 4.0 | 8.0 | Q3 |

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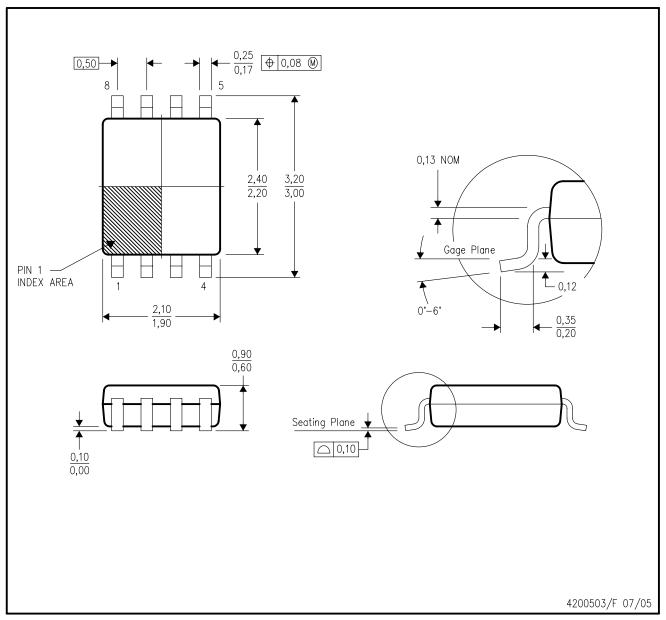


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) | |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|--|
| TS5A3357QDCURQ1 | US8 | DCU | 8 | 3000 | 202.0 | 201.0 | 28.0 | |

DCU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



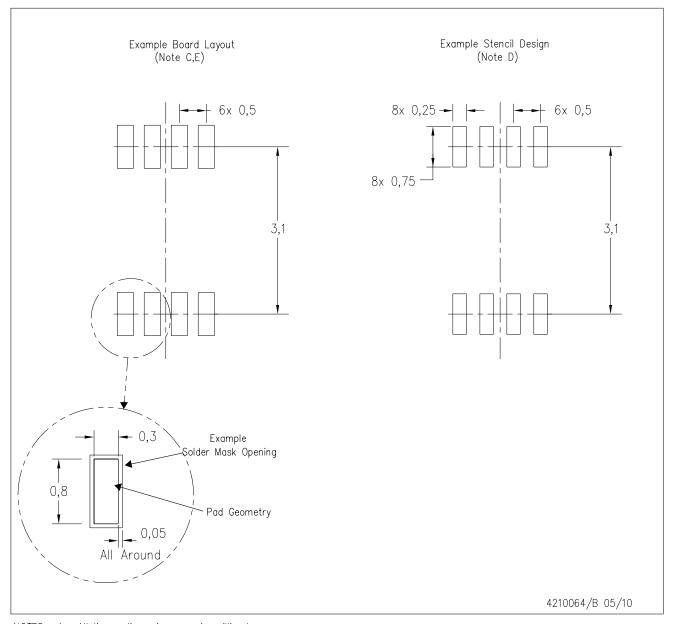
NOTES:

- ES: A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-187 variation CA.



DCU (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE (DIE DOWN)



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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